

DESCRIPTION

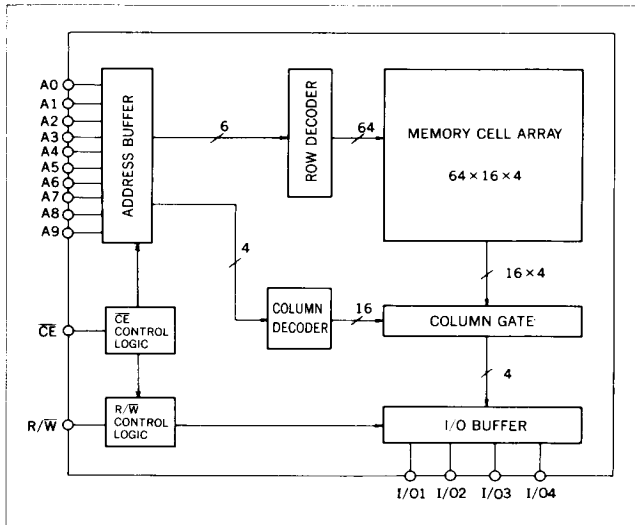
The SRM2114₂₅ is a 1,024 words x 4 bits asynchronous, static, random access memory on a monolithic CMOS chip. Its very low standby current consumption makes it ideal for applications requiring non-volatile storage with back-up batteries. The static nature of the memory requires no external clock or refreshing circuit.

Both the input and output ports are TTL compatible; and the three-state output allows easy expansion of memory capacity. These features make the SRM2114₂₅ usable for a wide range of applications from microprocessor systems to terminal devices.

FEATURES

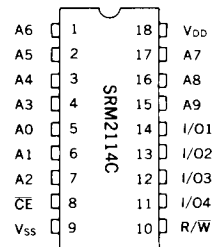
- Access time 250ns (Max)
- Single power supply ... 5V±10%/3 to 5V
- Low supply current Standby : 0.1µA (Typ)/0.1µA (Typ)
Operation: 14mA(Typ)/9mA (Typ)
- Completely static operation
- TTL compatible inputs and outputs
- 3-state output with wired-OR capability
- Operation with back-up batteries
- Package 18-pin DIP(plastic)
24-pin SOP (plastic)

BLOCK DIAGRAM

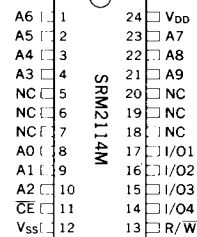


PIN CONFIGURATION

● 18-pin DIP



● 24-pin SOP



NC : no connection

PIN DESCRIPTION

A0 to A9	Address Input
R/W	Read/Write
CE	Chip Enable
I/O1 to 4	Data Input/Output
Vdd	Power Supply (+)
Vss	Power Supply (-)

■ ABSOLUTE MAXIMUM RATINGS

(V_{SS}=0V)

Parameter	Symbol	Ratings	Unit
Supply voltage	V _{DD}	-0.5 to 7.0	V
Input voltage	V _I	-0.5 to 7.0	V
I/O voltage	V _{I/O}	-0.5 to V _{DD} +0.3	V
Power dissipation	P _D	1.0	W
Operating temperature	T _{opr}	-40 to 85	°C
Storage temperature	T _{stg}	-65 to 150	°C
Soldering temperature and time	T _{sol}	260°C, 10s (at lead)	—

■ RECOMMENDED DC OPERATING CONDITIONS

Parameter	Symbol	SRM211425			Unit
		Min	Typ	Max	
Supply Voltage	V _{DD}	4.5	5.0	5.5	V
	V _{SS}	—	0	—	
Input Voltage	V _{IH}	2.2	—	V _{DD} + 0.3	V
	V _{IL}	-0.3	—	0.8	V

■ ELECTRICAL CHARACTERISTICS

● DC Electrical Characteristics

(SRM211425 . . . V_{DD} = 5V ± 10%, V_{SS} = 0V, T_a = -40 to 85°C)

Parameter	Symbol	SRM211425				Unit
		Conditions	Min	Typ	Max	
Input leakage current	I _{LI}	V _I = 0 to V _{DD}	-1.0	—	1.0	μA
Standby supply current	I _{DDS}	$\overline{CE} = V_{DD} - 0.2V$	—	0.1	5	μA
Operating supply current	I _{DDO}	$\overline{CE} = V_{IL}$ *CL = 100pF	—	*14	*35	mA
Output leakage current	I _{LO}	V _O = 0 to V _{DD}	-1.0	—	1.0	μA
High level output voltage	V _{OH}	I _{OH} = -1.0mA	2.4	—	—	V
Low level output voltage	V _{OL}	I _{OL} = 2.0 mA	—	—	0.4	V

*CL = 0pF Typ7 Max 25

● Terminal Capacitance

(f = 1MHz, SRM211425 . . . V_{DD} = 5V ± 10%, V_{SS} = 0V, T_a = -40 to 85°C)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input capacitance	C _I	V _I = 0V	—	—	7	pF
I/O capacitance	C _{I/O}	V _{I/O} = 0V	—	—	10	pF

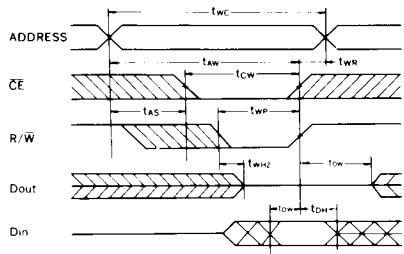
● AC Electrical Characteristics

○ Read Cycle

(SRM211425 . . . V_{DD} = 5V ± 10%, V_{SS} = 0V, T_a = -40 to 85°C)

Parameter	Symbol	Conditions	SRM211425		Unit
			Min	Max	
Read cycle time	t _{RC}	*1	250	—	ns
Address access time	t _{ACC}		—	250	ns
$\overline{CE}$ access time	t _{ACE}		—	250	ns
$\overline{CE}$ output set time	t _{CLZ}	*2	0	—	ns
$\overline{CE}$ output floating	t _{CHZ}		—	120	ns
Output hold time	t _{OH}	*1	10	—	ns

○ Write Cycle

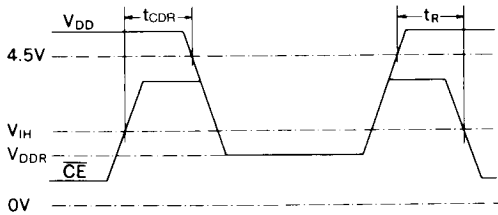


■ DATA RETENTION CHARACTERISTICS WITH LOW SUPPLY VOLTAGE

(SRM211425 Ta = -40 to 85°C)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Data retention supply voltage	VDDR	$V_I = 0$ or V_{DD} , $\overline{CE} = V_{DD}$	2.0	—	5.5	V
Data retention supply current	IDDR	$V_{DD} = 2.0V$, 25°C	—	—	2	μA
$\overline{CE}$ setup time	tCDR	Refer to the Figure Below	0	—	—	ns
$\overline{CE}$ recovery time	tR		tRC*	—	—	ns

Data retention timing



* When retaining data in standby mode, supply voltage can be lowered within a certain range. But read or write cycle cannot be performed while the supply voltage is low.

CHARACTERISTICS CURVES

